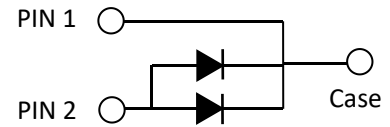


NOD60065H

Silicon Carbide Schottky Diode



Maximum Ratings ($T_c = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | Unit | Test Conditions | Note |
|----------------|--|----------------|------------------|---|--------|
| V_{RRM} | Repetitive Peak Reverse Voltage | 650 | V | | |
| V_{RSM} | Surge Peak Reverse Voltage | 650 | V | | |
| V_{DC} | DC Blocking Voltage | 650 | V | | |
| I_F | Continuous Forward Current | 60 | A | $T_C = 150^\circ\text{C}$ | Fig. 7 |
| I_{FRM} | Repetitive Peak Forward Surge Current | 350 | A | $T_C = 25^\circ\text{C}$, $t_p = 10$ ms, Half Sine Wave | |
| I_{FSM} | Non-Repetitive Peak Forward Surge Current | 450 | A | $T_C = 25^\circ\text{C}$, $t_p = 10$ ms, Half Sine Wave | |
| $I_{F,Max}$ | Non-Repetitive Peak Forward Surge Current | 2500 | A | $T_C = 25^\circ\text{C}$, $t_p = 10$ μs , Pulse | |
| P_{tot} | Power Dissipation | 555 240 | W | $T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$ | Fig. 6 |
| T_J, T_{stg} | Operating Junction and Storage Temperature | -55 to +175 | $^\circ\text{C}$ | | |

Electrical Characteristics

| Symbol | Parameter | Typ. | Max. | Unit | Test Conditions | Note |
|--------|---------------------------|--------------------|------------|---------------|---|--------|
| V_F | Forward Voltage | 1.45 1.95 | 1.8 2.4 | V | $I_F = 60$ A $T_J = 25^\circ\text{C}$ $I_F = 60$ A $T_J = 175^\circ\text{C}$ | Fig. 1 |
| I_R | Reverse Current | 2 40 | 20 200 | μA | $V_R = 650$ V $T_J = 25^\circ\text{C}$ $V_R = 650$ V $T_J = 175^\circ\text{C}$ | Fig. 2 |
| Q_C | Total Capacitive Charge | 170 | | nC | $V_R = 400$ V, $T_J = 25^\circ\text{C}$ $Q_C = \int_0^{V_R} C(V) dV$ | Fig. 4 |
| C | Total Capacitance | 4100 325 274 | | pF | $V_R = 0$ V, $T_J = 25^\circ\text{C}$, $f = 1$ MHz $V_R = 200$ V, $T_J = 25^\circ\text{C}$, $f = 1$ MHz $V_R = 400$ V, $T_J = 25^\circ\text{C}$, $f = 1$ MHz | Fig. 3 |
| E_C | Capacitance Stored Energy | 42 | | μJ | $V_R = 400$ V | Fig. 5 |

Thermal Characteristics

| Symbol | Parameter | Typ. | Unit | Note |
|-----------------|--|------|---------------------------|--------|
| $R_{\theta JC}$ | Thermal Resistance from Junction to Case | 0.27 | $^\circ\text{C}/\text{W}$ | Fig. 8 |

Typical Performance

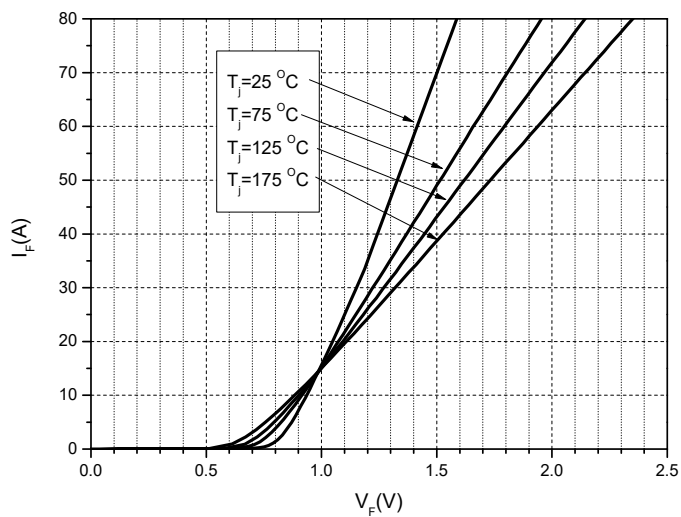


Figure 1. Forward Characteristics

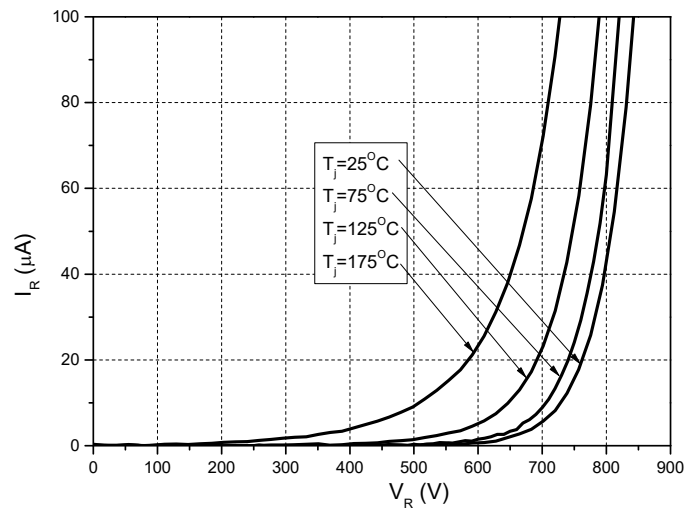


Figure 2. Reverse Characteristics

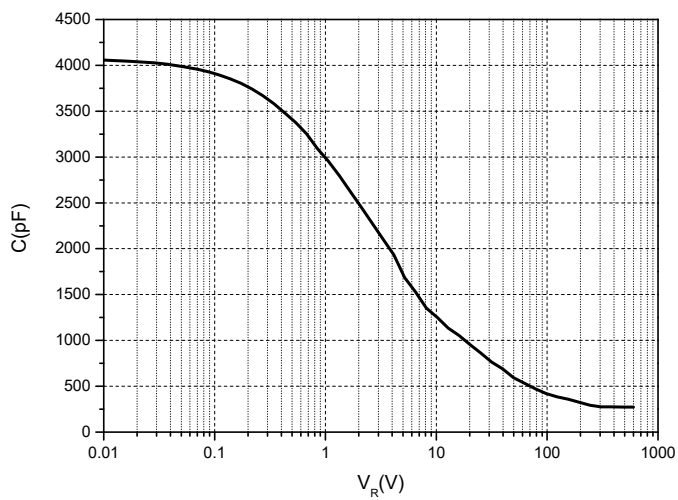


Figure 3. Capacitance vs. Reverse Voltage

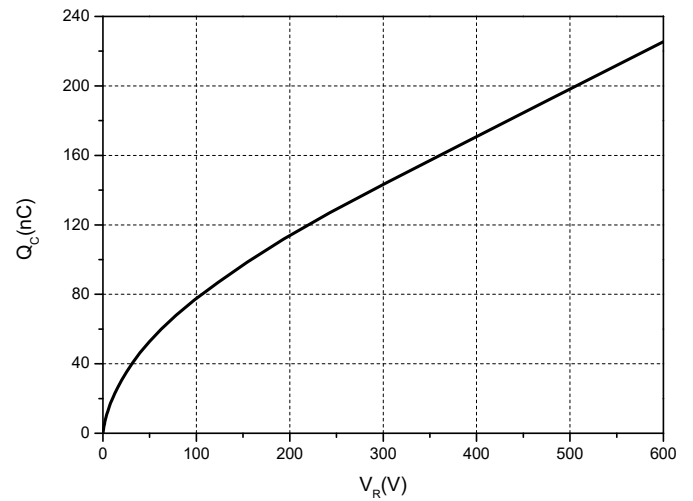


Figure 4. Total Capacitance Charge vs. Reverse Voltage

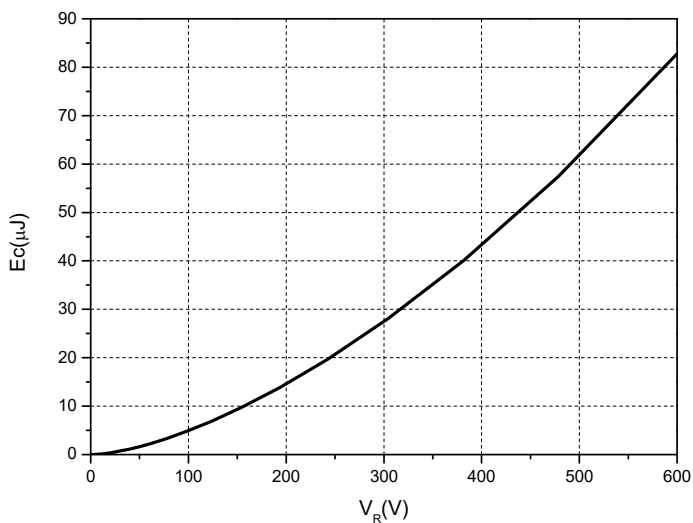


Figure 5. Capacitance Stored Energy

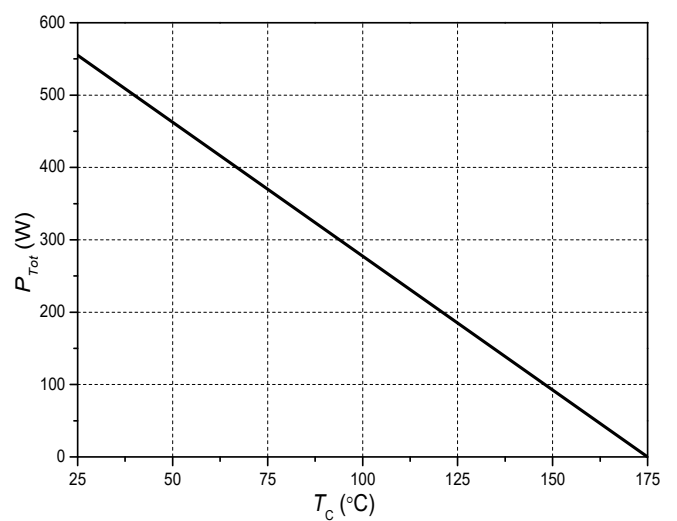


Figure 6. Power Derating

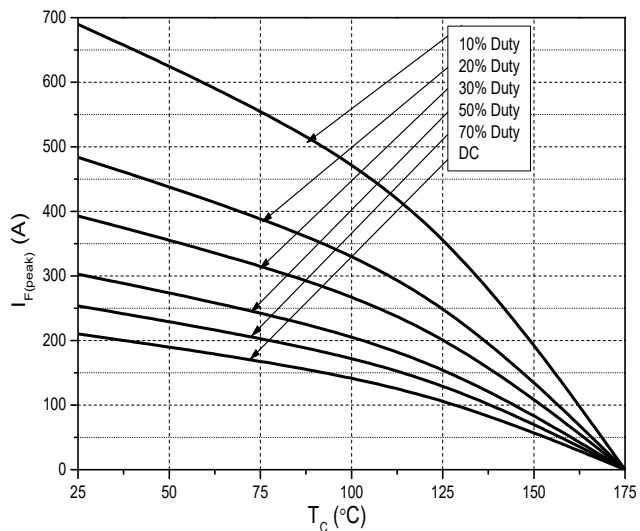


Figure 7. Current Derating

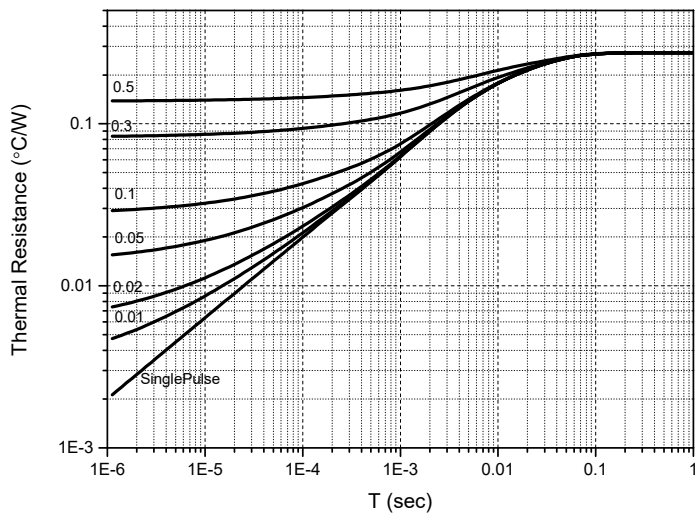


Figure 8. Transient Thermal Impedance

Package Dimensions: TO-247-2L

